SEAGATE

Laptop SSHD

SATA Product Manual

Standard models

ST1000UM000

ST750UM000

100725145, Rev. E
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Document Revision History

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Contents

Figures

Seagate® Technology Support Services

For information regarding online support and services, visit: http://www.seagate.com/contacts/

For information regarding Warranty Support, visit: http://www.seagate.com/support/warranty-and-replacements/

For information regarding data recovery services, visit: http://www.seagate.com/services-software/seagate-recovery-services/recover/

For Seagate OEM, Distribution partner portal and reseller portal, visit: http://www.seagate.com/partners/

1.0 Introduction

This manual describes the functional, mechanical and interface specifications for the following Seagate® Laptop SSHD model drives:

Standard models
ST1000UM000
ST750UM000

These drives provide the following key features:

- 5400-RPM spindle speed.
- 64MB buffer.
- 16GB NAND flash

Note	For improved reliability, Seagate SSHDs incorporate a technique referred to as 'Combo Mode', utilizing proprietary controls to reduce the number of bits stored to a portion of the NAND Flash.

- Quiet operation. Fluid Dynamic Bearing (FDB) motor.
- High instantaneous (burst) data-transfer rates (up to 6Gb/s).
- Perpendicular recording technology.
- State-of-the-art cache and on-the-fly error-correction algorithms.
- Native Command Queuing (NCQ) with command ordering.
- Full-track multiple-sector transfer capability without local processor intervention.
- 1000 Gs nonoperating shock and 350 Gs of operating shock.
- SeaTools™ diagnostic software performs a drive self-test that eliminates unnecessary drive returns.
- The 3D Defense System™, which includes Drive Defense, Data Defense and Diagnostic Defense, offers the industry's most comprehensive protection for disk drives.
- Support for S.M.A.R.T. drive monitoring and reporting.
- Support for Read Multiple and Write Multiple commands.
- Worldwide Name (WWN) capability uniquely identifies the drive.

1.1 About the Serial ATA Interface

The Serial ATA interface provides several advantages over the traditional (parallel) ATA interface. The primary advantages include:

- Easy installation and configuration with true plug-and-play connectivity. It is not necessary to set any jumpers or other configuration options.
- Thinner and more flexible cabling for improved enclosure airflow and ease of installation.
- Scalability to higher performance levels.

In addition, Serial ATA makes the transition from parallel ATA easy by providing legacy software support. Serial ATA was designed to allow users to install a Serial ATA host adapter and Serial ATA disk drive in the current system and expect all of the existing applications to work as normal.

The Serial ATA interface connects each disk drive in a point-to-point configuration with the Serial ATA host adapter. There is no master/slave relationship with Serial ATA devices like there is with parallel ATA. If two drives are attached on one Serial ATA host adapter, the host operating system views the two devices as if they were both "masters" on two separate ports. This essentially means both drives behave as if they are Device 0 (master) devices.

Note	The host adapter may, optionally, emulate a master/slave environment to host software where two devices on separate Serial ATA ports are represented to host software as a Device 0 (master) and Device 1 (slave) accessed at the same set of host bus addresses. A host adapter that emulates a master/slave environment manages two sets of shadow registers. This is not a typical Serial ATA environment.

The Serial ATA host adapter and drive share the function of emulating parallel ATA device behavior to provide backward compatibility with existing host systems and software. The Command and Control Block registers, PIO and DMA data transfers, resets, and interrupts are all emulated.

The Serial ATA host adapter contains a set of registers that shadow the contents of the traditional device registers, referred to as the Shadow Register Block. All Serial ATA devices behave like Device 0 devices. For additional information about how Serial ATA emulates parallel ATA, refer to the *Serial ATA International Organization: Serial ATA* (Revision 3.0). The specification can be downloaded from www.serialata.org.

2.0 Drive Specifications

Unless otherwise noted, all specifications are measured under ambient conditions, at 25°C, and nominal power. For convenience, the phrases *the drive* and *this drive* are used throughout this manual to indicate the following drive models:

The specification summaries listed in the following tables are for quick reference. For details on specification measurement or definition, refer to the appropriate section of this manual.

Table 1 Drive Specifications Summary

Drive Specification	ST1000UM000	ST750UM000
Formatted capacity (1)	1TB	750 GB
Guaranteed sectors	1,953,525,168	1,465,149,168
Heads	4	
Disks	2	
Bytes per sector	512 (logical) / 4096 (physical)	
NAND flash Commercial Multilevel Cell (cMLC)	16GB	
Recording density	1894 Kb/in	
Track density	375 Ktracks/in avg	
Areal density	705 Gb/in2 avg	
Spindle speed	5400 RPM	
Sustained data transfer rate OD	100 MB/s max	
I/O data-transfer rate	600 MB/s max	
ATA data-transfer modes supported	PIO modes 0–4 Multiword DMA modes 0–2 Ultra DMA modes 0–6	
Cache buffer	64 MB	
Height	9.5 +/- 0.2 mm (0.374 +/-.008 in)	
Width	69.85 +/- 0.25 mm (2.750 +/- 0.010 in)	
Length	100.35 +0.20 / -0.25 mm (3.951 +0.008 / -0.010 in)	
Weight (typical)	115 g (0.254 lb)	
Average latency	5.6 ms	
Startup current (typical) 5V (peak)	1.0 A	
Voltage tolerance (including noise)	5V ± 5%	
Operating temperature	0° to 60°C	
Nonoperating temperature (Ambient)	–40° to 70°C	
Temperature gradient (max)	20°C per hour max (operating) 35°C per hour max (nonoperating)	
Relative humidity	5% to 95% (operating) 5% to 95% (nonoperating)	
Relative humidity gradient	30% per hour max	
Wet bulb temperature (max)	37.7°C max (operating) 40.0°C max (nonoperating)	
Altitude, operating	–304.8 m to 3048 m (–1000 ft to 10,000+ ft)	

Table 1 Drive Specifications Summary (continued)

Drive Specification	ST1000UM000	ST750UM000
Altitude, nonoperating (below mean sea level, max)	–304.8 m to 12,192 m (–1000 ft to 40,000+ ft)	
Operational Shock	350 Gs at 2 ms max	
Non-Operational Shock	1000 Gs at 1 ms max	
Vibration, operating	5–200 Hz: 2.0 Gs 201–500 Hz: 1.0 Gs	
Vibration, nonoperating	5–500 Hz: 5.0 Gs	
Nonrecoverable read errors	1 per 10^{15} bits read	
Annualized Failure Rate (AFR)	1%	
Rated workload	Average annualized workload rating: <55 TB/year. The AFR specification for the product assumes the I/O workload does not exceed the average annualized workload rate limit of 55 TB/year. Workloads exceeding the annualized rate may degrade the product AFR and impact reliability as experienced by the particular application. The average annualized workload rate limit is in units of TB per calendar year.	
Warranty	To determine the warranty for a specific drive, use a web browser to access the following web page: http://www.seagate.com/support/warranty-and-replacements/ From this page, click on the "Is my Drive under Warranty" link. Users will be asked to provide the drive serial number, model number (or part number) and country of purchase. The system will display the warranty information for the drive.	
Load-unload cycles	600,000 at 25°C, 50% rel. humidity	
Supports Hotplug operation per the Serial ATA Revision 2.6 specification	Yes	

1. One GB equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

2.1 Formatted Capacity

Model	Formatted Capacity(1)	Guaranteed Sectors	Bytes per Sector
ST1000UM000	1000 GB	1,953,525,168	512 (logical) / 4096 (physical)
ST750UM000	750 GB	1,465,149,168	

1. One GB equals one billion bytes when referring to hard drive capacity. Accessible capacity may vary depending on operating environment and formatting.

2.1.1 LBA mode

When addressing these drives in LBA mode, all blocks (sectors) are consecutively numbered from 0 to *n–1,* where *n* is the number of guaranteed sectors as defined above.

Refer to **Configuring and Mounting the Drive** on page 16 (words 60-61 and 100-103) for additional information about 48-bit addressing support of drives with capacities over 137 GB.

2.2 Physical organization

Drive model	Read/write heads	Number of discs
ST1000UM000	4	2
ST750UM000		

2.3 Recording and Interface Technology

Interface	Serial ATA (SATA)
Recording method	Perpendicular
Recording density	1894 Kb/in
Track density	375 ktracks/in avg
Areal density	705 Gb/in^2 avg
Spindle speed	5400 RPM +/- 0.2%
Sustained data transfer rate	100 MB/s max
I/O data-transfer rate	600 MB/s max

2.4 Physical Characteristics

All models	Height	9.5 +/- 0.2 mm (0.374 +/-.008 in)
	Width	69.85 +/- 0.25 mm (2.750 +/- 0.010 in)
	Length	100.35 +0.20 / -0.25 mm (3.951 +0.008 / -0.010 in)
	Typical weight	115 g (0.254 lb)
	Cache buffer	64 MB (64,768 KB)

2.5 Seek time

Seek measurements are taken with nominal power at 25°C ambient temperature. All times are measured using drive diagnostics. The specifications in the table below are defined as follows:

- Track-to-track seek time is an average of all possible single-track seeks in both directions.
- Average seek time is a true statistical random average of at least 5000 measurements of seeks between random tracks, less overhead.

Table 2 Typical seek times

Typical seek times (ms)	Read
Track-to-track	2.0
Average	12.0
Average latency	5.6

Note	These drives are designed to consistently meet the seek times represented in this manual. Physical seeks, regardless of mode (such as track-to-track and average), are expected to meet the noted values. However, due to the manner in which these drives are formatted, benchmark tests that include command overhead or measure logical seeks may produce results that vary from these specifications.

2.6 Start/stop times

Table 3 Start/stop times

Typical seek times (ms)	Typical	Max @ 25°C
Power-on to ready (sec)	<1.0	<1.0
Standby to ready (sec)	<1.0	<1.0

2.7 Power Specifications

The drive receives DC power (+5V) through a native SATA power connector (refer to **Figure 2**).

2.7.1 Power consumption

Power requirements for the drives are listed in the table in **Table 4**. Typical power measurements are based on an average of drives tested, under nominal conditions, at 25°C ambient temperature. These power measurements are done with Interface Power Management modes like HIPM and DIPM enabled.

- **Spinup power**
  Spinup power is measured from the time of power-on to the time that the drive spindle reaches operating speed.
- **Seek mode**
  During seek mode, the read/write actuator arm moves toward a specific position on the disk surface and does not execute a read or write operation. Servo electronics are active. Seek mode power is measured based on three random seek operations every 100 ms. This mode is not typical.
- **Read/write power and current**
  Read/write power is measured with the heads on track, based on three 63 sector read or write operations every 100 ms.
- **Idle mode power**
  Idle mode power is measured with the drive up to speed, with servo electronics active and with the heads in a random track location.
- **Standby mode**
  During standby mode, the drive accepts commands, but the drive is not spinning, and the servo and read/write electronics are in power-down mode.

Table 4 DC Power Requirements

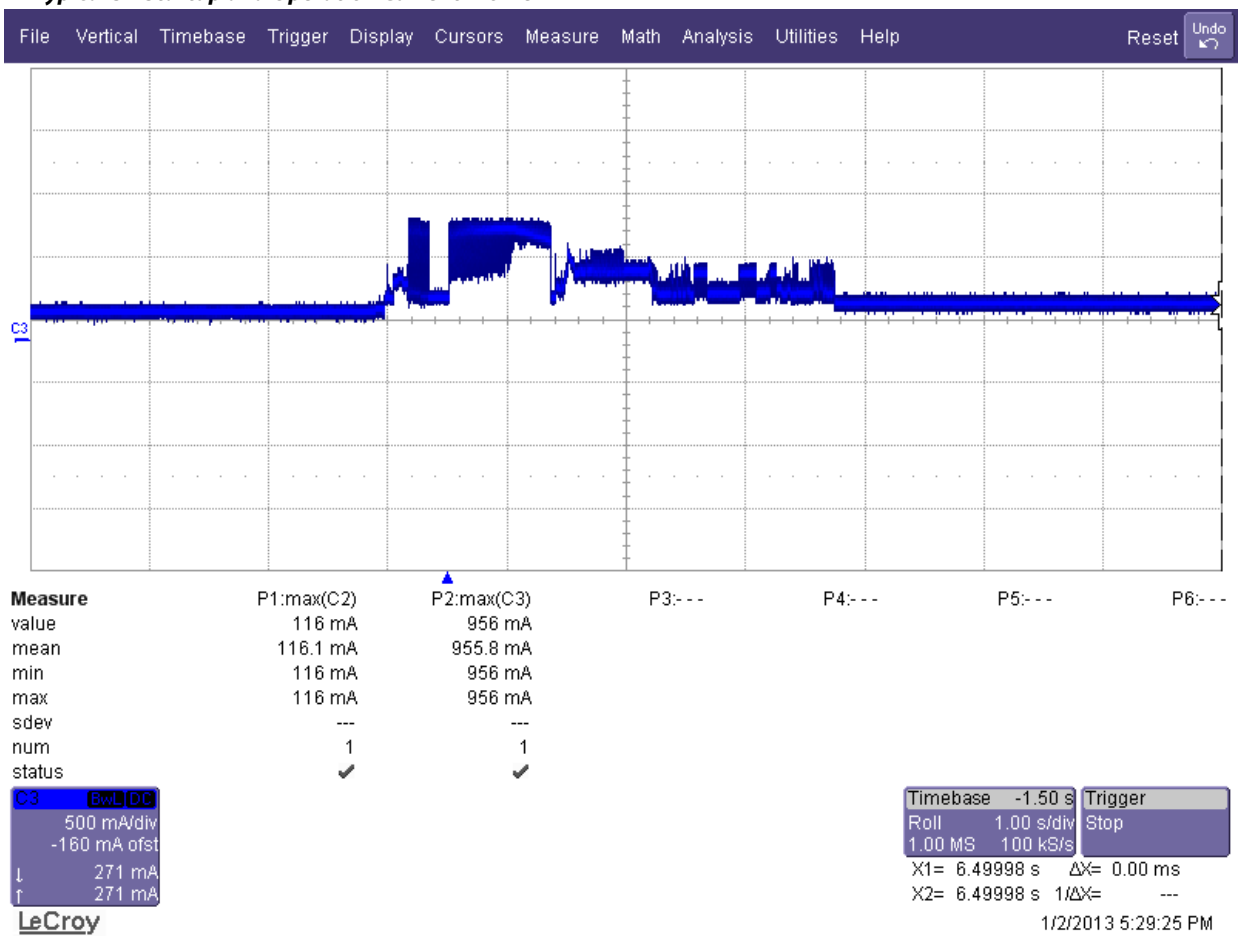
Power Dissipation	+5V input average (25° C)
Spinup (max)	1.50A
Seek average	2.7W
Write average	3.7W
Read average	3.1W
Idle, performance (1)	2.2W
Idle, active	1.1W
Idle, low power mode	0.9W
Standby(2)	0.53W
Sleep	0.53W

1. During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.
2. Standby power is measured at steady state (after 200ms from transition)

2.7.1.1 Typical current profiles

The typical 5V startup and operation current profile is shown in **Figure 1**.

Figure 1 Typical 5V Startup and Operation Current Profile



2.7.2 Conducted noise

Input noise ripple is measured at the host system power supply across an equivalent 15-ohm resistive load on the +5 volt line.

- Using 5-volt power, the drive is expected to operate with a maximum of 100 mV peak-to-peak square-wave injected noise at up to 10 MHz.

Note	Equivalent resistance is calculated by dividing the nominal voltage by the typical RMS read/write current.

2.7.3 Voltage tolerance

Voltage tolerance (including noise):

- +5V ± 5%

2.7.4 Power management modes

The drive provides programmable power management to provide greater energy efficiency. In most systems, power management is controlled through the system setup program. The drive features the following power-management modes:

Power modes	Heads	Spindle	Buffer
Active (operating)	Tracking	Rotating	Full power
Idle, performance	Tracking	Rotating	Self refresh—low power
Idle, active	Floating	Rotating	Self refresh—low power
Idle, low power	Parked	Rotating	Self refresh—low power
Standby	Parked	Stopped	Self refresh—low power
Sleep	Parked	Stopped	Self refresh—low power

- **Active mode**
  The drive is in active mode during the read/write and seek operations.

- **Idle mode**
  The buffer remains enabled, and the drive accepts all commands and returns to active mode any time disk access is necessary.

- **Standby mode**
  The drive enters standby mode when the host sends a standby Immediate command. If the host has set the standby timer, the drive can also enter standby mode automatically after the drive has been inactive for a specifiable length of time. The standby timer delay is established using a standby or idle command. In standby mode, the drive buffer is enabled, the heads are parked and the spindle is at rest. The drive accepts all commands and returns to active mode any time disk access is necessary.

- **Sleep mode**
  The drive enters sleep mode after receiving a sleep command from the host. In sleep mode, the drive buffer is disabled, the heads are parked and the spindle is at rest. The drive leaves sleep mode after it receives a hard reset or soft reset from the host. After receiving a reset, the drive exits sleep mode and enters standby mode with all current translation parameters intact.

- **Idle and standby timers**
  Each time the drive performs an active function (read, write or seek), the standby timer is reinitialized and begins counting down from its specified delay times to zero. If the standby timer reaches zero before any drive activity is required, the drive makes a transition to standby mode. In both Idle and standby mode, the drive accepts all commands and returns to active mode when disk access is necessary.

2.8 Environmental Specifications

This section provides the temperature, humidity, shock, and vibration specifications for Seagate Laptop SSHD drives. Ambient temperature is defined as the temperature of the environment immediately surrounding the drive. Above 1000 feet (305 meters), the maximum temperature is derated linearly by 1°C every 1000 feet.

Table 5: Environmental specifications

Parameters	Operating	Non-Operating
Ambient temperature	0° to 60°C (32° to 140°F)	-40° to 70°C (-40° to 158°F)
Temperature gradient	20°C per hour (68°F per hour) max, without condensation	35°C per hour (95°F per hour) max, without condensation
Humidity	5% to 95% non-condensing (30% per hour)	5% to 95% non-condensing (30% per hour)
Wet bulb	37.7°C (99.8°F) max	40°C (104°F) max
Altitude	-304.8m to 3048m (-1000ft to 10,000ft)	-304.8m to 12,192m (-1000ft to 40,000ft)

Note	The recommended storage period: • 1 year under controlled conditions of 34°C 90%RH or less • 90 days in uncontrolled storage conditions

2.8.1 Shock

All shock specifications assume that the drive is mounted securely with the input shock applied at the drive mounting screws. Shock may be applied in the X, Y, or Z axis.

2.8.1.1 Operating shock

These drives comply with the performance levels specified in this document when subjected to a maximum operating shock of 350 Gs based on half-sine shock pulses of 2ms. Shocks should not be repeated more than one time per axis

2.8.1.2 Nonoperating shock

The nonoperating shock level that the drive can experience without incurring physical damage or degradation in performance when subsequently put into operation is 800 Gs based on a nonrepetitive half-sine shock pulse of 2 ms duration.

The nonoperating shock level that the drive can experience without incurring physical damage or degradation in performance when subsequently put into operation is 1000 Gs based on a nonrepetitive half-sine shock pulse of 1 ms duration.

2.8.2 Vibration

All vibration specifications assume that the drive is mounted securely with the input vibration applied at the drive mounting screws. Vibration may be applied in the X, Y, or Z axis.

2.8.2.1 Operating vibration

The maximum vibration levels that the drive may experience while meeting the performance standards specified in this document are specified below.

5–200 Hz	2.0 Gs (0 to peak). Max displacement may apply below 10 Hz.
201–500 Hz	1.0 Gs (0 to peak).

2.8.2.2 Nonoperating vibration

The maximum nonoperating vibration levels that the drive may experience without incurring physical damage or degradation in performance when subsequently put into operation are specified below.

5–500 Hz	5.0 Gs (0 to peak). Max displacement may apply below 22 Hz.

2.9 Acoustics

Drive emission of sound is measured consistent with the ECMA-74 and its referenced standards. Testing is conducted at room temperature (approximately 25°C). Emission levels are reported as the total A-weighted sound power levers for steady state, idle, and active seeks modes of operation.

Table 6 Drive A-weighted Sound Power Levels (SWL, BA)

Idle[1]	Performance Seek
2.2 bels (typ) 2.4 bels (max)	2.4 bels (typ) 2.6 bels (max)

1. During periods of drive idle, some offline activity may occur according to the S.M.A.R.T. specification, which may increase acoustic and power to operational levels.

2.9.1 Test for prominent discrete tones (PDTs)

Seagate follows the ECMA-74 standards for measurement and identification of PDTs. An exception to this process is the use of the absolute threshold of hearing. Seagate uses the lower limit for the threshold curve* to discern tone audibility and to compensate for the inaudible components of sound prior to computation of tone ratios according to Annex D of the ECMA-74 standards.

*Defined as the median curve given by ISO 389-7 (Tf curve) minus 10dB at all frequencies.

2.10 Electromagnetic Immunity

When properly installed in a representative host system, the drive operates without errors or degradation in performance when subjected to the radio frequency (RF) environment as defined in **Table 7**.

Table 7 Radio Frequency Environments

Test	Description	Performance Level	Reference Standard
Electrostatic discharge	Contact, HCP, VCP: ± 4 kV; Air: ± 8 kV	B	EN 61000-4-2: 95
Radiated RF immunity	80 to 1,000 MHz, 3 V/m, 80% AM with 1 kHz sine 900 MHz, 3 V/m, 50% pulse modulation @ 200 Hz	A	EN 61000-4-3: 96 ENV 50204: 95
Electrical fast transient	± 1 kV on AC mains, ± 0.5 kV on external I/O	B	EN 61000-4-4: 95
Surge immunity	± 1 kV differential, ± 2 kV common, AC mains	B	EN 61000-4-5: 95
Conducted RF immunity	150 kHz to 80 MHz, 3 Vrms, 80% AM with 1 kHz sine	A	EN 61000-4-6: 97
Power Frequency H-field immunity	1 A/m, 50Hz/60Hz, 3 axes	A	EN 61000-4-8: 97
Voltage dips, interrupts	30% Reduction for 25 cycles >95% Reduction for 250 cycles >95%, 0.5 cycles	C C B	EN 61000-4-11: 94

2.11 Reliability

Nonrecoverable read errors	1 per 10^{15} bits read, max
Annualized Failure Rate (AFR)	1%
Load/Unload (U/UL) 25°C, 50% relative humidity	600,000 software-controlled power on/off cycles 20,000 hard power on/off cycles
Rated workload	Average annualized workload rating: <55 TB/year. The AFR specification for the product assumes the I/O workload does not exceed the average annualized workload rate limit of 55 TB/year. Workloads exceeding the annualized rate may degrade the product AFR and impact reliability as experienced by the particular application. The average annualized workload rate limit is in units of TB per calendar year.
Warranty	To determine the warranty for a specific drive, use a web browser to access the following web page: http://www.seagate.com/support/warranty-and-returns From this page, click on the "Is my Drive under Warranty" link. Users will be asked to provide the drive serial number, model number (or part number) and country of purchase. The system will display the warranty information for the drive.

2.12 Agency Certification

2.12.1 Safety certification

These products are certified to meet the requirements of UL60950-1, CSA60950-1 and EN60950 and so marked as to the certify agency.

2.12.2 Electromagnetic Compatibility (EMC)

Hard drives that display the CE mark comply with the European Union (EU) requirements specified in the Electromagnetic Compatibility Directive (2004/108/EC) as put into place 20 July 2007. Testing is performed to the levels specified by the product standards for Information Technology Equipment (ITE). Emission levels are defined by EN 55022, Class B and the immunity levels are defined by EN 55024.

Drives are tested in representative end-user systems. Although CE-marked Seagate drives comply with the directives when used in the test systems, we cannot guarantee that all systems will comply with the directives. The drive is designed for operation inside a properly designed enclosure, with properly shielded I/O cable (if necessary) and terminators on all unused I/O ports. Computer manufacturers and system integrators should confirm EMC compliance and provide CE marking for their products.

Korean RRL

If these drives have the Korean Communications Commission (KCC) logo, they comply with paragraph 1 of Article 11 of the Electromagnetic Compatibility control Regulation and meet the Electromagnetic Compatibility (EMC) Framework requirements of the Radio Research Laboratory (RRL) Communications Commission, Republic of Korea.

These drives have been tested and comply with the Electromagnetic Interference/Electromagnetic Susceptibility (EMI/EMS) for Class B products. Drives are tested in a representative, end-user system by a Korean-recognized lab.

- Certificate number: IKCC-REM-STX-LaptopSSHD
- Trade name or applicant: Seagate Technology LLC
- Certificate date: 14 December, 2012
- Manufacturer/nationality: USA, Singapore and China

Australian C-Tick (N176)

If these models have the C-Tick marking, they comply with the Australia/New Zealand Standard AS/NZS3548 1995 and meet the Electromagnetic Compatibility (EMC) Framework requirements of the Australian Communication Authority (ACA).

2.12.3 FCC verification

These drives are intended to be contained solely within a personal computer or similar enclosure (not attached as an external device). As such, each drive is considered to be a subassembly even when it is individually marketed to the customer. As a subassembly, no Federal Communications Commission verification or certification of the device is required.

Seagate has tested this device in enclosures as described above to ensure that the total assembly (enclosure, disk drive, motherboard, power supply, etc.) does comply with the limits for a Class B computing device, pursuant to Subpart J, Part 15 of the FCC rules. Operation with noncertified assemblies is likely to result in interference to radio and television reception.

Radio and television interference. This equipment generates and uses radio frequency energy and if not installed and used in strict accordance with the manufacturer's instructions, may cause interference to radio and television reception.

This equipment is designed to provide reasonable protection against such interference in a residential installation. However, there is no guarantee that interference will not occur in a particular installation. If this equipment does cause interference to radio or television, which can be determined by turning the equipment on and off, users are encouraged to try one or more of the following corrective measures:

- Reorient the receiving antenna.
- Move the device to one side or the other of the radio or TV.
- Move the device farther away from the radio or TV.
- Plug the computer into a different outlet so that the receiver and computer are on different branch outlets.

If necessary, users should consult the dealer or an experienced radio/television technician for additional suggestions. Users may find helpful the following booklet prepared by the Federal Communications Commission: *How to Identify and Resolve Radio-Television Interference Problems*. This booklet is available from the Superintendent of Documents, U.S. Government Printing Office, Washington, DC 20402. Refer to publication number 004-000-00345-4.

2.13 Environmental Protection

Seagate designs its products to meet environmental protection requirements worldwide, including regulations restricting certain chemical substances.

2.13.1 European Union Restriction of Hazardous Substances (RoHS) Directive

The European Union Restriction of Hazardous Substances (RoHS) Directive, restricts the presence of chemical substances, including Lead, Cadmium, Mercury, Hexavalent Chromium, PBB and PBDE, in electronic products, effective July 2006. This drive is manufactured with components and materials that comply with the RoHS Directive.

2.13.2 China Restriction of Hazardous Substances (RoHS) Directive 中国限制危险物品的指令

This product has an Environmental Protection Use Period (EPUP) of 20 years. The following table contains information mandated by China's "Marking Requirements for Control of Pollution Caused by Electronic Information Products" Standard.

该产品具有20年的环境保护使用周期 （EPUP）。 下表包含了中国 “电子产品所导致的污染的控制的记号要求”所指定的信息。

Name of Parts 部件名称	Toxic or Hazardous Substances or Elements有毒有害物质或元素					
	Lead 铅 （Pb）	Mercury 汞 （Hg）	Cadmium 镉 （Cd）	Hexavalent Chromium 六价铬 （Cr6+）	Polybrominated Diphenyl 多溴联苯 （PBB）	Polybrominated Diphenyl Ether 多溴二苯醚 （PBDE）
PCBA	X	O	O	O	O	O
HDA	X	O	O	O	O	O

"O" indicates the hazardous and toxic substance content of the part (at the homogenous material level) is lower than the threshold defined by the China RoHS MCV Standard.

“O”表示该部件（于同类物品程度上）所含的危险和有毒物质低于中国RoHS MCV标准所定义的门槛值。

"X" indicates the hazardous and toxic substance content of the part (at the homogenous material level) is over the threshold defined by the China RoHS MCV Standard.

“X”表示该部件（于同类物品程度上）所含的危险和有毒物质超出中国RoHS MCV标准所定义的门槛值。

2.14 Corrosive Environment

Seagate electronic drive components pass accelerated corrosion testing equivalent to 10 years exposure to light industrial environments containing sulfurous gases, chlorine and nitric oxide, classes G and H per ASTM B845. However, this accelerated testing cannot duplicate every potential application environment.

Users should use caution exposing any electronic components to uncontrolled chemical pollutants and corrosive chemicals as electronic drive component reliability can be affected by the installation environment. The silver, copper, nickel and gold films used in Seagate products are especially sensitive to the presence of sulfide, chloride, and nitrate contaminants. Sulfur is found to be the most damaging. In addition, electronic components should never be exposed to condensing water on the surface of the printed circuit board assembly (PCBA) or exposed to an ambient relative humidity greater than 95%. Materials used in cabinet fabrication, such as vulcanized rubber, that can outgas corrosive compounds should be minimized or eliminated. The useful life of any electronic equipment may be extended by replacing materials near circuitry with sulfide-free alternatives.

3.0 Configuring and Mounting the Drive

This section contains the specifications and instructions for configuring and mounting the drive.

3.1 Handling and Static-Discharge Precautions

After unpacking, and before installation, the drive may be exposed to potential handling and electrostatic discharge (ESD) hazards. Observe the following standard handling and static-discharge precautions.

CAUTION	• Keep the drive in the electrostatic discharge (ESD) bag until users are ready for installation to limit the drive's exposure to ESD. • Before handling the drive, put on a grounded wrist strap, or ground oneself frequently by touching the metal chassis of a computer that is plugged into a grounded outlet. Wear a grounded wrist strap throughout the entire installation procedure. • Handle the drive by its edges or frame *only*. • The drive is extremely fragile—handle it with care. Do not press down on the drive top cover. • Always rest the drive on a padded, antistatic surface until users mount it in the computer. • Do not touch the connector pins or the printed circuit board. • Do not remove the factory-installed labels from the drive or cover them with additional labels. Removal voids the warranty. Some factory-installed labels contain information needed to service the drive. Other labels are used to seal out dirt and contamination.

3.2 Configuring the Drive

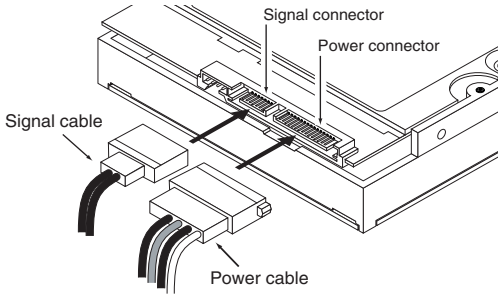
Each drive on the Serial ATA interface connects in a point-to-point configuration with the Serial ATA host adapter. There is no master/slave relationship because each drive is considered a master in a point-to-point relationships. If two drives are attached on one Serial ATA host adapter, the host operating system views the two devices as if they were both "masters" on two separate ports. Both drives behave as if they are Device 0 (master) devices.

3.2.1 Serial ATA Cables and Connectors

The Serial ATA interface cable consists of four conductors in two differential pairs, plus three ground connections. The cable size may be 30 to 26 AWG with a maximum length of one meter (39.37 in). Refer to **Table 8** for connector pin definitions. Either end of the SATA signal cable can be attached to the drive or host.

For direct backplane connection, the drive connectors are inserted directly into the host receptacle. The drive and the host receptacle incorporate features that enable the direct connection to be hot pluggable and blind mateable. For installations which require cables, users can connect the drive as shown in **Figure 2**.

Figure 2 Attaching SATA Cabling



Each cable is keyed to ensure correct orientation. Seagate Laptop SSHD SATA drives support latching SATA connectors.

3.3 Drive Mounting

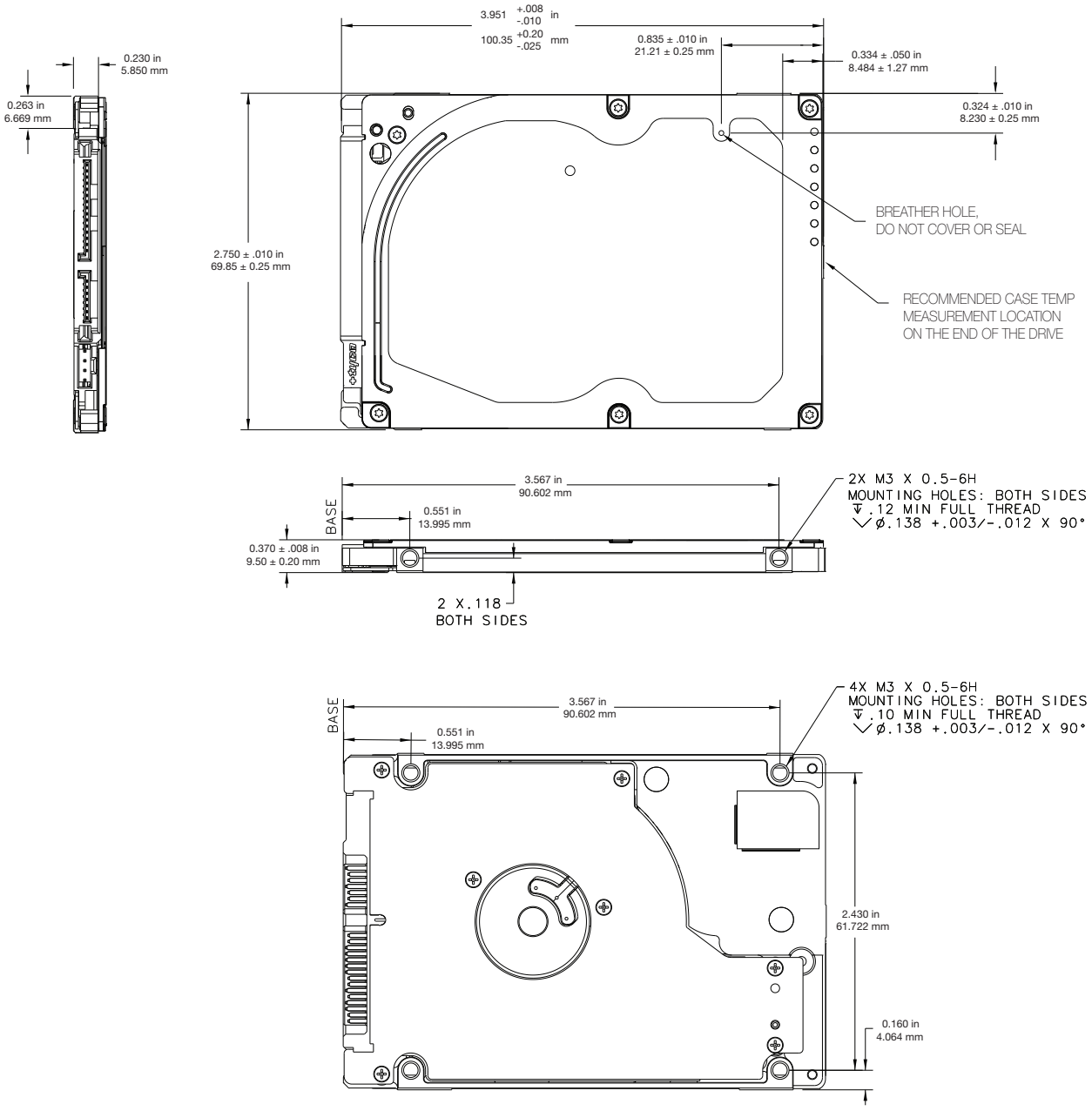
Users can mount the drive in any orientation using four screws in the side-mounting holes or four screws in the bottom-mounting holes. Refer to **Figure 3** for drive mounting dimensions. Follow these important mounting precautions when mounting the drive:

- Allow a minimum clearance of 0.030 in (0.76 mm) around the entire perimeter of the drive for cooling.
- Use only M3 x 0.5 mounting screws.
- Do not overtighten the mounting screws. Maximum torque: 4.0 in-lb (0.4519 N-m).
- Four (4) threads (0.080 in, 2.032 mm) minimum screw engagement recommended.

- Avoid excessive drive distortion when mounting. Refer to the following specifications for stiffness/deflection information:

Top cover stiffness/deflection	
Operating: no performance degradation, emitted noise, mechanical damage, or hard errors	10 mm probe: 1.02kgf or 5 mm probe: 0.92kgf
Non-operating: no hard errors	20 mm probe: 2.0kgf at any point of top cover 20 mm probe: 15.0kgf at top cover edges only

Figure 3 Mounting Dimensions (for standard models))



Note	For reference only. May not represent actual drive.

4.0 Serial ATA (SATA) Interface

These drives use the industry-standard Serial ATA interface that supports FIS data transfers. It supports ATA programmed input/output (PIO) modes 0–4; multiword DMA modes 0–2, and Ultra DMA modes 0–6. The drive also supports the use of the IORDY signal to provide reliable high-speed data transfers.

For detailed information about the Serial ATA interface, refer to the *Serial ATA: High Speed Serialized AT Attachment* specification.

4.1 Hot-Plug Compatibility

Seagate Laptop SSHD SATA drives incorporate connectors which enable users to hot plug these drives in accordance with the Serial ATA: High Speed Serialized AT Attachment specification revision 2.0. This specification can be downloaded from www.serialata.org. This device requires a COMRESET from the host after a hotplug event.

4.2 Serial ATA Device Plug Connector Pin Definitions

Table 8 summarizes the signals on the Serial ATA interface and power connectors. Refer to the **Notes** below.

Table 8 Serial ATA Connector Pin Definitions

Segment	Pin	Function	Definition
Signal	S1	Ground	2nd mate
	S2	A+	Differential signal pair A from Phy
	S3	A-	
	S4	Ground	2nd mate
	S5	B-	Differential signal pair B from Phy
	S6	B+	
	S7	Ground	2nd mate
Key and spacing separate signal and power segments			
Power	P1	V_{33}	3.3V power
	P2	V_{33}	3.3V power
	P3	V_{33}	3.3V power, pre-charge, 2nd mate
	P4	Ground	1st mate
	P5	Ground	2nd mate
	P6	Ground	2nd mate
	P7	V_5	5V power, pre-charge, 2nd mate
	P8	V_5	5V power
	P9	V_5	5V power
	P10	Ground	2nd mate
	P11	Ground or LED signal	If grounded, drive does not use deferred spin
	P12	Ground	1st mate
	P13	V_{12}	12V power, pre-charge, 2nd mate
	P14	V_{12}	12V power
	P15	V_{12}	12V power

Notes

1. All pins are in a single row, with a 1.27 mm (0.050 in) pitch.
2. The comments on the mating sequence apply to the case of backplane blindmate connector only. In this case, the mating sequences are:
   - the ground pins P4 and P12.
   - the pre-charge power pins and the other ground pins.
   - the signal pins and the rest of the power pins.
3. There are three power pins for each voltage. One pin from each voltage is used for pre-charge when installed in a blind-mate backplane configuration.
4. All used voltage pins (V_x) must be terminated.

4.3 Supported ATA Commands

Table 9 lists Serial ATA standard commands that the drive supports. For a detailed description of the ATA commands, refer to the *Serial ATA International Organization: Serial ATA* (Revision 2.6). Refer to www.sata-io.org.

Refer to **S.M.A.R.T. commands** on page 25 for details and subcommands used in the S.M.A.R.T. implementation.

Table 9 Supported ATA commands

ATA-standard commands names	Command code (in hex)	
Device Configuration Restore	B1h/C0h	
Device Configuration Freeze Lock	B1h/C1h	
Device Configuration Identify	B1h/C2h	
Device Configuration Set	B1h/C3h	
Download Microcode	92h	
Execute Device Diagnostics	90h	
Flush Cache	E7h	
Flush Cache Extended	EAh	
Identify Device	ECh	
Initialize Device Parameters	91h	
Read Buffer	E4h	
Read DMA	C8h	
Read DMA Extended	25h	
Read DMA without Retries	C9h	
Read Long with Retries	22h	
Read Long without Retries	23h	
Read Multiple	C4h	
Read Multiple Extended	29h	
Read Native Max Address	F8h	
Read Native Max Address Extended	27h	
Read Sectors	20h	
Read Sectors Extended	24h	
Read Sectors without Retries	21h	
Read Verify Sectors	40h	
Read Verify Sectors Extended	42h	
Read Verify Sectors without Retries	41h	
Seek	70h	
Set Features	EFh	
Set Max Address	F9h	
Note: Individual Set Max commands are identified by the value placed in the Set Max Features register as defined to the right.	Address: Password: Lock: Unlock: Freeze Lock:	00_H 01_H 02_H 03_H 04_H
Set Max Address Ext	37h	
Set Multiple Mode	C6h	
S.M.A.R.T. Disable Operations	B0h/D9h	
S.M.A.R.T. Enable/Disable Autosave	B0h/D2h	

Table 9 Supported ATA commands

ATA-standard commands names	Command code (in hex)
S.M.A.R.T. Enable Operations	B0h/D8h
S.M.A.R.T. Enable/Disable Auto Offline	B0h/DBh
S.M.A.R.T. Enable One Attribute Modification	B0h/E0h
S.M.A.R.T. Execute Offline	B0h/D4h
S.M.A.R.T. Free Fall Protection Host Interface	FEh
S.M.A.R.T. Read Attribute Thresholds	B0h/D1h
S.M.A.R.T. Read Data	B0h/D0h
S.M.A.R.T. Read Log Sector	B0h/D5h
S.M.A.R.T. Return Status	B0h/DAh
S.M.A.R.T. Save Attribute Values	B0h/D3h
S.M.A.R.T. Write Attribute Thresholds	B0h/D7h
S.M.A.R.T. Write Attribute Values	B0h/E1h
S.M.A.R.T. Write Log Sector	B0h/D6h
Write Buffer	E8h
Write DMA	CAh
Write DMA Extended	35h
Write DMA without Retries	CBh
Write Long with Retries	32h
Write Long without Retries	33h
Write Multiple	C5h
Write Multiple Extended	39h
Write Sectors	30h, 31h
Write Sectors Extended	34h
ATA-standard power-management commands	
Check Power Mode	E5h
Idle	E3h
Idle Immediate	E1h
Sleep	E6h
Standby	E2h
Standby Immediate	E0h
ATA-standard security commands	
Security Set Password	F1h
Security Unlock	F2h
Security Erase Prepare	F3h
Security Erase Unit	F4h
Security Freeze Lock	F5h
Security Disable Password	F6h

4.3.1 Identify Device command

The Identify Device command (command code EC_H) transfers information about the drive to the host following power up. The data is organized as a single 512-byte block of data, whose contents are shown in **Table 10**. All reserved bits or words should be set to zero. Parameters listed with an "x" are drive-specific or vary with the state of the drive. Refer to **Drive Specifications** on page 6 for default parameter settings.

The following commands contain drive-specific features that may not be included in the Serial ATA specification.

Table 10 Identify Device command

Word	Description	Value
0	Configuration information: • Bit 15: 0 = ATA; 1 = ATAPI • Bit 7: removable media • Bit 6: removable controller • Bit 0: reserved	$0C5A_H$
1	Number of logical cylinders	16,383
2	Specific configuration	$C837_H$
3	Number of logical heads	16
4	Retired	0000_H
5	Retired	0000_H
6	Number of logical sectors per logical track: 63	$003F_H$
7–9	Retired	0000_H
10–19	Serial number: (20 ASCII characters, 0000_H = none)	ASCII
20	Retired	0000_H
21	Retired	8000_H
22	Obsolete	0004_H
23–26	Firmware revision: (8 ASCII character string, padded with blanks to end of string)	x.xx
27–46	Drive model number: (40 ASCII characters, padded with blanks to end of string)	ST1000UM000 ST750UM000
47	(Bits 7–0) Maximum sectors per interrupt on Read multiple and Write multiple (16)	8010_H
48	Trusted Computing Feature set options	0000_H
49	Standard Standby timer, IORDY supported and may be disabled	$2F00_H$
50	Capabilities	4000_H
51	PIO data-transfer cycle timing mode	0200_H
52	Retired	0200_H
53	Words 54–58, 64–70 and 88 are valid	0007_H
54	Number of current logical cylinders	$xxxx_H$
55	Number of current logical heads	$xxxx_H$
56	Number of current logical sectors per logical track	$xxxx_H$
57–58	Current capacity in sectors	$xxxx_H$
59	Number of sectors transferred during a Read Multiple or Write Multiple command	$xxxx_H$
60–61	Total number of user-addressable sectors This field contains a value that is one greater than the total number of user-addressable sectors. The maximum value that shall be placed in this field is 0FFFFFFFh. The 0FFFFFFFh value applies to all capacities over 137GB (see Section 2.1 for related information).	ST1000UM000 = 0FFFFFFFh ST750UM000 = 0FFFFFFFh
62	Retired	0000_H

Table 10 Identify Device command

Word	Description	Value
63	Multiword DMA active and modes supported (see note following this table)	*xx*07$_H$
64	Advanced PIO modes supported (modes 3 and 4 supported)	0003$_H$
65	Minimum multiword DMA transfer cycle time per word (120 ns)	0078$_H$
66	Recommended multiword DMA transfer cycle time per word (120 ns)	0078$_H$
67	Minimum PIO cycle time without IORDY flow control (240 ns)	0078$_H$
68	Minimum PIO cycle time with IORDY flow control (120 ns)	0078$_H$
69–74	ATA-reserved	0000$_H$
75	Queue depth	001F$_H$
76	Serial ATA capabilities	0D06$_H$
77	ATA-reserved	0000$_H$
78	Serial ATA features supported	0048$_H$
79	Serial ATA features enabled	0048$_H$
80	Major version number	01F0$_H$
81	Minor version number	0029$_H$
82	Command sets supported	746B$_H$
83	Command sets supported	7D69$_H$
84	Command sets support extension	61E3$_H$
85	Command sets enabled	7469
86	Command sets enabled	BC49$_H$
87	Command sets enable extension	61E3$_H$
88	Ultra DMA support and current mode (see note following this table)	*xx*7F$_H$
89	Security erase time	*xxxx*$_H$
90	Enhanced security erase time	*xxxx*$_H$
91	Current APM values	8080$_H$
92	Master password revision code	FFFE$_H$
93	Hardware reset value (see description following this table)	*xxxx*$_H$
94	Auto acoustic management setting	*xxxx*$_H$
95	Stream Min. Request Size	0000$_H$
96	Streaming Transfer Time - DMA	0000$_H$
97	Streaming Access Latency - DMA and PIO	0000$_H$
98-99	Streaming Performance Granularity	0000$_H$
100–103	Total number of user-addressable LBA sectors available (see Section 3.2 for related information) These words are required for drives that support the 48-bit addressing feature. Maximum value: 0000FFFFFFFFFFFFh.	ST1000UM000 = 1,953,525,168 ST750UM000 = 1,465,149,168
104	Streaming Transfer Time - PIO	0000$_H$
105	Reserved	0000$_H$
106	Physical sector size / Logical sector size	6003$_H$
107	Seagate reserved	0000$_H$

Table 10 Identify Device command

Word	Description	Value
108-111	The mandatory value of the world wide name (WWN) for the drive. **NOTE:** This field is valid if word 84, bit 8 is set to 1 indicating 64-bit WWN support.	Each drive will have a unique value.
112-118	ATA-reserved	0000_H
119	Free Fall Protection support (bit 5)	1 = Free Fall Protection supported 0 = Free Fall Protection not supported
120	Free Fall Protection enable/disable (bit 5)	1 = Free Fall Protection feature is enabled 0 = Free Fall Protection feature is disabled
121–127	ATA-reserved	0000_H
128	Security status	0021_H
129–159	Seagate-reserved	$xxxx_H$
160–221	ATA-reserved	0000_H
222	Transport major version number	$101F_H$
223–254	ATA-reserved	0000_H
255	Integrity word	$xxA5_H$

Note	See the bit descriptions below for words 63, 88 and 93 of the Identify Drive data.

Table 11 Bit Descriptions

Description (if bit is set to 1)	
Bit	**Word 63**
0	Multiword DMA mode 0 is supported.
1	Multiword DMA mode 1 is supported.
2	Multiword DMA mode 2 is supported.
8	Multiword DMA mode 0 is currently active.
9	Multiword DMA mode 1 is currently active.
10	Multiword DMA mode 2 is currently active.
Bit	**Word 88**
0	Ultra DMA mode 0 is supported.
1	Ultra DMA mode 1 is supported.
2	Ultra DMA mode 2 is supported.
3	Ultra DMA mode 3 is supported.
4	Ultra DMA mode 4 is supported.
5	Ultra DMA mode 5 is supported.
6	Ultra DMA mode 6 is supported.
8	Ultra DMA mode 0 is currently active.
9	Ultra DMA mode 1 is currently active.
10	Ultra DMA mode 2 is currently active.
11	Ultra DMA mode 3 is currently active.
12	Ultra DMA mode 4 is currently active.

Table 11 Bit Descriptions (continued)

13	Ultra DMA mode 5 is currently active.
14	Ultra DMA mode 6 is currently active.
Bit	**Word 93**
13	1 = 80-conductor cable detected, CBLID above VIH 0 = 40-conductor cable detected, CBLID below VIL

4.3.2 Set Features command

This command controls the implementation of various features that the drive supports. When the drive receives this command, it sets BSY, checks the contents of the Features register, clears BSY and generates an interrupt. If the value in the register does not represent a feature that the drive supports, the command is aborted. Power-on default has the read look-ahead and write caching features enabled.

The acceptable values for the Features register are defined as follows:

Table 12 Set Features command values

02_H	Enable write cache *(default)*.
03_H	Set transfer mode (based on value in Sector Count register). Sector Count register values: 00_H Set PIO mode to default (PIO mode 2). 01_H Set PIO mode to default and disable IORDY (PIO mode 2). 08_H PIO mode 0 09_H PIO mode 1 $0A_H$ PIO mode 2 $0B_H$ PIO mode 3 $0C_H$ PIO mode 4 *(default)* 20_H Multiword DMA mode 0 21_H Multiword DMA mode 1 22_H Multiword DMA mode 2 40_H Ultra DMA mode 0 41_H Ultra DMA mode 1 42_H Ultra DMA mode 2 43_H Ultra DMA mode 3 44_H Ultra DMA mode 4 45_H Ultra DMA mode 5 46_H Ultra DMA mode 6
55_H	Disable read look-ahead (read cache) feature.
82_H	Disable write cache
AA_H	Enable read look-ahead (read cache) feature *(default)*.
$C1_H$	Disable the Free Fall Protection feature (41_H above enables the Free Fall Protection feature)
$F1_H$	Report full capacity available

Note	At power-on, or after a hardware or software reset, the default values of the features are as indicated above

4.3.3 S.M.A.R.T. commands

S.M.A.R.T. provides near-term failure prediction for disk drives. When S.M.A.R.T. is enabled, the drive monitors predetermined drive attributes that are susceptible to degradation over time. If self-monitoring determines that a failure is likely, S.M.A.R.T. makes a status report available to the host. Not all failures are predictable. S.M.A.R.T. predictability is limited to the attributes the drive can monitor. For more information on S.M.A.R.T. commands and implementation, see the *Draft ATA-5 Standard*.

SeaTools diagnostic software activates a built-in drive self-test (DST S.M.A.R.T. command for $D4_H$) that eliminates unnecessary drive returns. The diagnostic software ships with all new drives and is also available at:
http://www.seagate.com/support/downloads/seatools/.

This drive is shipped with S.M.A.R.T. features disabled. users must have a recent BIOS or software package that supports S.M.A.R.T. to enable this feature. The table below shows the S.M.A.R.T. command codes that the drive uses.

Table 13 S.M.A.R.T. Commands

Code in features register	S.M.A.R.T. command
$D0_H$	S.M.A.R.T. Read Data
$D2_H$	S.M.A.R.T. Enable/Disable Attribute Autosave
$D3_H$	S.M.A.R.T. Save Attribute Values
$D4_H$	S.M.A.R.T. Execute Off-line Immediate (runs DST)
$D5_H$	S.M.A.R.T. Read Log Sector
$D6_H$	S.M.A.R.T. Write Log Sector
$D8_H$	S.M.A.R.T. Enable Operations
$D9_H$	S.M.A.R.T. Disable Operations
DA_H	S.M.A.R.T. Return Status

Note	If an appropriate code is not written to the Features Register, the command is aborted and 0*x*04 (abort) is written to the Error register.

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